BGA Heat Sink - High Performance maxiFLOW/superGRIP



ATS Part#:

Description:

Heat Sink Type: maxiFLOW Heat Sink Attachment: Equivalent Part Number: N/A

superGRIP

ATS-X50375B-C1-R0

37.50 x 37.50 x 7.50 mm BGA Heat Sink - High Performance maxiFLOW/superGRIP

*Image above is for illustration purpose only.

Features & Benefits

- Designed for 37.5 x 37.5 mm components •
- Requires minimal space around the component's perimeter; ideal for densely populated PCBs •
- Allows the heat sink to be detached and reattached without damaging the component or the PCB, an important feature in the event a • PCB may need to be reworked
- Strong, uniform attachment force helps achieve maximum performance from phase-changing TIMs
- Eliminates the need to drill mounting holes in the PCB .

Thermal Performance

		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	4.9 °C/W	3.6 °C/W	3 °C/W	2.7 °C/W	2.5 °C/W	2.3 °C/W	2.1 °C/W
	Ducted Flow	3.3	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	ТІМ	Finish
	37.50 mm	37.50 mm	7.50 mm	51.4 mm	T766	BLUE-ANODIZED
•Image above is for illustration purpose only.	 Dimension Thermal papplication ATS resense performar ATS certifier 	rves the right to upda	eight from the bottor e provided for referen ate or change its pro- k assembly is RoHS	nce only. Actual perfo ducts without notice -6 and REACH comp	ormance to improv	may vary by

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.

